

STL52DN4LF7AG

Automotive-grade dual N-channel 40 V, 9 mΩ typ., 18 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 DI

Datasheet - production data

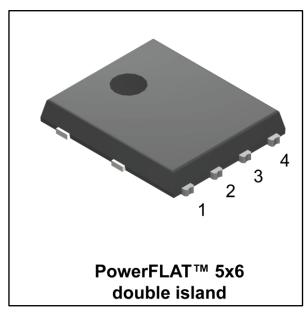
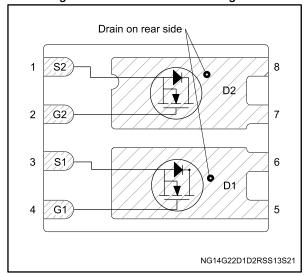


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D
STL52DN4LF7AG	40 V	16 mΩ	18 A



- AEC-Q101 qualified
- Among the lowest R_{DS(on)} on the market
- Excellent FoM (figure of merit)
- Low C_{rss}/C_{iss} ratio for EMI immunity
- High avalanche ruggedness
- Wettable flank package

Applications

• Switching applications

Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summary

Order code	Marking	Package	Packing
STL52DN4LF7AG	52DN4LF7	PowerFLAT™ 5x6 double island	Tape and reel

December 2017 DocID029278 Rev 4 1/16

Contents STL52DN4LF7AG

Contents

1	Electric	al ratings3
2	Electric	al characteristics4
	2.1	Electrical characteristics (curves)6
3	Test cir	cuits8
4	Packag	e information9
	4.1	PowerFLAT™ 5x6 double island WF type R package information. 10
	4.2	Packing information13
5	Revisio	n history15

STL52DN4LF7AG Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{DS}	Drain-source voltage	40	V	
V _{GS}	Gate-source voltage	±20	V	
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	18	Α	
I _D ⁽¹⁾	Drain current (continuous) at T _c = 100 °C	18	Α	
I _{DM} ⁽¹⁾⁽²⁾	Drain current (pulsed)	72	Α	
Ртот	Total dissipation at T _C = 25 °C	65	W	
T _{stg}	Storage temperature range		°C	
TJ	Operation junction temperature range	-55 to 175 °C		

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	2.3	0000
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	32	°C/W

Notes:

⁽¹⁾Drain current is limited by package, the current capability of the silicon is 46 A at 25 °C and 33 A at 100 °C.

⁽²⁾Pulse width limited by safe operating area

 $^{^{(1)}\!}When$ mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 s

Electrical characteristics STL52DN4LF7AG

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4: On/Off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	40			>
IDSS	Zero gate voltage drain current	$V_{GS} = 0 V$ $V_{DS} = 40 V$			10	μΑ
lgss	Gate-body leakage current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.5		2.5	٧
Danie I	Static drain-source	V _{GS} = 10 V, I _D = 6 A		9	16	mΩ
R _{DS(on)}	on-resistance	$V_{GS} = 4.5 \text{ V}, I_{D} = 6 \text{ A}$		12	20	11122

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	500	1	pF
Coss	Output capacitance	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz},$	1	140	1	pF
Crss	Reverse transfer capacitance	$V_{GS} = 0 V$	1	20	1	pF
Qg	Total gate charge	$V_{DD} = 20 \text{ V}, I_D = 12 \text{ A},$	1	9.4	1	nC
Q_{gs}	Gate-source charge	V _{GS} = 0 to 10 V	-	1.6	-	nC
Q_{gd}	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior")	1	2	1	nC

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 32 \text{ V}, I_D = 6 \text{ A},$	-	6.5	-	ns
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$	-	5	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 13: "Test circuit for resistive load switching times"	1	48	1	ns
t _f	Fall time	and Figure 18: "Switching time waveform")	-	14.5	-	ns

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} ⁽¹⁾	Source-drain current		ı		18	Α
I _{SDM} ⁽²⁾	Source-drain current (pulsed)		-		72	Α
V _{SD} ⁽³⁾	Forward on voltage	I _{SD} = 12 A, V _{GS} = 0 V	-		1.3	٧
t _{rr}	Reverse recovery time	I _{SD} = 12 A, di/dt = 100 A/μs	-	18		ns
Qrr	Reverse recovery charge	V _{DD} = 32 V (see Figure 15: "Test circuit for inductive load switching and diode recovery times")	-	7.5		nC
I _{RRM}	Reverse recovery current		-	0.8		Α

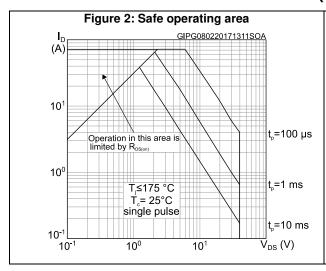
Notes:

 $^{^{(1)}}$ Drain current is limited by package, the current capability of the silicon is 46 A at 25 °C.

⁽²⁾ Pulse width limited by safe operating area.

 $^{^{(3)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%

2.1 Electrical characteristics (curves)



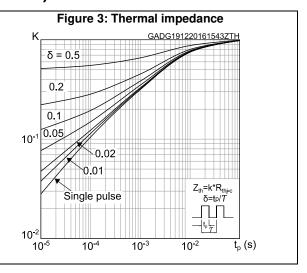


Figure 4: Output characteristics

GIPG1112201714040CH

(A)

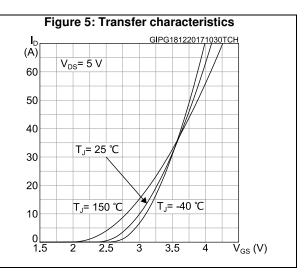
V_{GS}= 5, 6, 7, 8, 9, 10 V

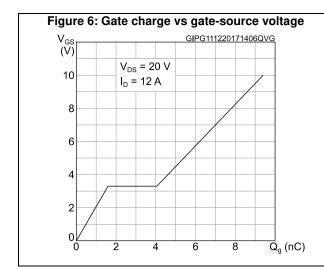
V_{GS}= 4 V

V_{GS}= 3 V

V_{GS}= 4 V

V_{GS}= 3 V





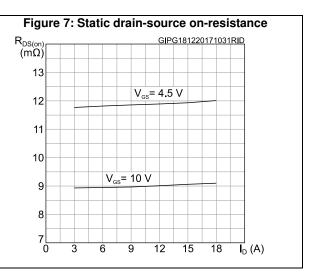
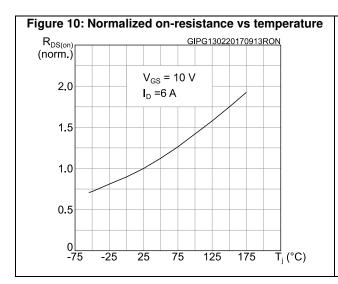
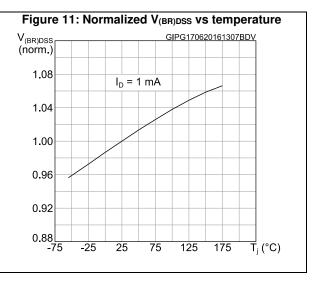
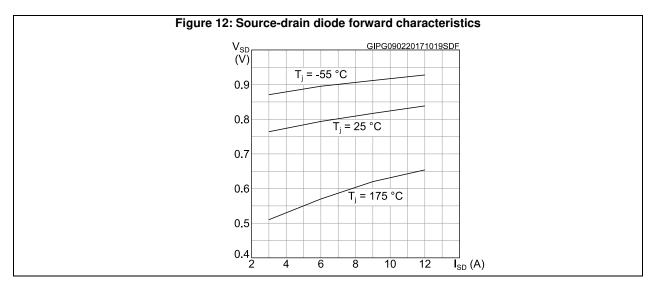


Figure 8: Capacitance variations $C \qquad \qquad GIPG080220171325CVR \qquad \qquad C_{ISS}$ $10^2 \qquad \qquad \qquad C_{OSS}$ $f = 1 \text{ MHz} \qquad \qquad C_{RSS}$ $10^1 \qquad \qquad 0 \qquad 10 \qquad 20 \qquad 30 \qquad 40 \qquad V_{DS} (V)$







Test circuits STL52DN4LF7AG

3 Test circuits

Figure 13: Test circuit for resistive load switching times

Figure 13: Test circuit for resistive load switching times

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Figure 13: Test circuit for resistive load switching times

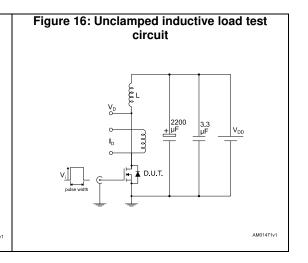
Figure 14: Test circuit for gate charge behavior

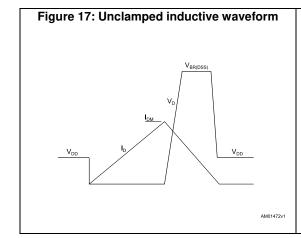
12 V 47 KQ 100 NF D.U.T.

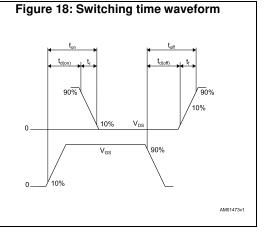
2200 PF 47 KQ 0VG

AM01469v1

Figure 15: Test circuit for inductive load switching and diode recovery times







4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



4.1 PowerFLAT™ 5x6 double island WF type R package information

Figure 19: PowerFLAT™ 5x6 double island WF type R package outline

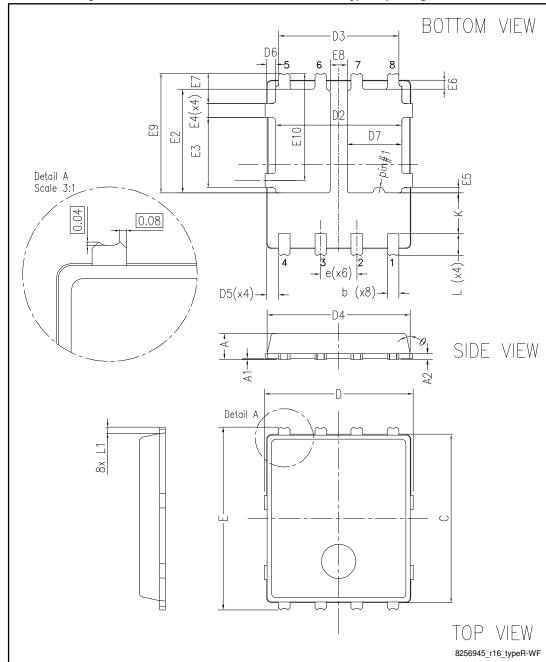
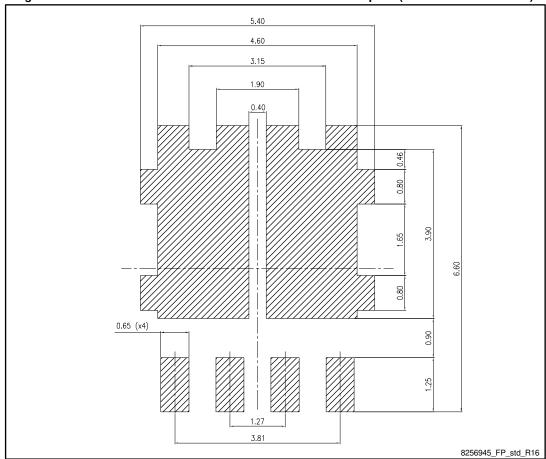


Table 8: PowerFLAT™ 5x6 double island WF type R mechanical data

	PowerFLAT 5x6 double	mm	
Dim.	Min.	Тур.	Max.
Α	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
С	5.80	6.00	6.10
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.10
D5	0.25	0.40	0.55
D6	0.15	0.30	0.45
D7	1.68		1.98
е		1.27	
E	6.20	6.40	6.60
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.85	1.00	1.15
E8	0.55		0.75
E9	4.00	4.20	4.40
E10	3.55	3.70	3.85
K	1.275		1.575
L	0.725	0.825	0.925
L1	0.175	0.275	0.375
θ	0°		12°





STL52DN4LF7AG Package information

4.2 Packing information

Figure 21: PowerFLAT™ 5x6 WF tape (dimensions are in mm)

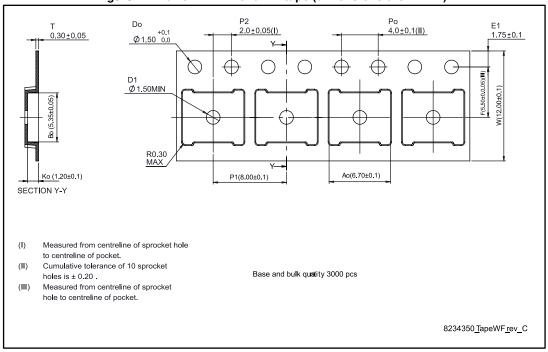
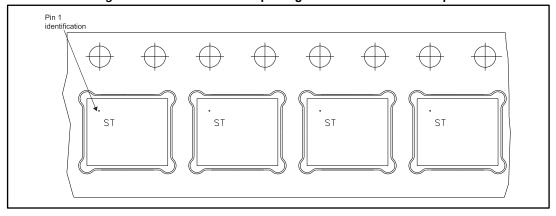


Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape



Package information STL52DN4LF7AG

R0.60

R25.00

Figure 23: PowerFLAT™ 5x6 reel (dimensions are in mm)

STL52DN4LF7AG Revision history

5 Revision history

Table 9: Document revision history

Date	Revision	Changes	
28-Apr-2016	1	First release.	
20-Jun-2016	2	Updated Figure 1: "Internal schematic diagram" and Section 7.1: "PowerFLAT™ 5x6 double island WF type R package information" Minor text changes.	
13-Sep-2016	3	Updated Section 5: "Electrical characteristics"	
18-Dec-2017	4	Datasheet promoted from preliminary data to production data. Modified title. Modified Table 4: "On/Off states", Table 5: "Dynamic", Table 6: "Switching times" and Table 7: "Source-drain diode". Added Section 5.1: "Electrical characteristics (curves)". Minor text changes.	

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